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N-Channel PowerTrench[®] SyncFETTM 30 V, 42 A, 4 m Ω

Features

- Max $r_{DS(on)}$ = 4.0 m Ω at V_{GS} = 10 V, I_D = 18 A
- Max $r_{DS(on)}$ = 4.5 m Ω at V_{GS} = 7 V, I_D = 16 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

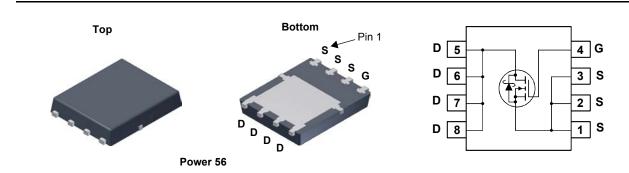


General Description

The FDMS7672AS has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25 °C		42		
	-Continuous (Silicon limited)	T _C = 25 °C		83	•	
D	-Continuous	T _A = 25 °C	(Note 1a)	19	— A	
	-Pulsed			90		
dv/dt	MOSFET dv/dt			2.6	V/ns	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	60	mJ	
D	Power Dissipation	T _C = 25 °C		46	14/	
PD	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	- W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		2.7	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7672AS	FDMS7672AS	Power 56	13 "	12 mm	3000 units

October 2014

Off Chara	Parameter	Test Conditions	Min	Тур	Max	Units	
	Interistics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V	
ΔBV _{DSS}	Breakdown Voltage Temperature		00				
ΔT_J	Coefficient	I_D = 10 mA, referenced to 25 °C		18		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			500	μA	
I _{GSS}	Gate to Source Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA	
	cteristics (Note 2)						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.9	3.0	V	
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage						
ΔT_J	Temperature Coefficient	I_D = 10 mA, referenced to 25 °C		-5		mV/°C	
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 18 A		3.2	4.0		
-		V _{GS} = 7 V, I _D = 16 A	3.5 4.5		4.5]	
DS(on)		V _{GS} = 4.5 V, I _D = 14 A		4.3	5.2	mΩ	
		V_{GS} = 10 V, I _D = 18 A, T _J = 125 °C	4.1 5.2				
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 18 A		97		S	
Jynamic	Characteristics						
C _{iss}	Input Capacitance			2120	2820	pF	
C _{iss} C _{oss}	Output Capacitance	V _{DS} = 15 V, V _{GS} = 0 V,		735	975	pF	
C _{oss} C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		90	135	pF	
o _{rss} R _g	Gate Resistance			1.1	2.2	Ω	
*							
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time			12	21	ns	
t _r	Rise Time	V _{DD} = 15 V, I _D = 18 A,		5	10	ns	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		28	44	ns	
t _f	Fall Time			4	10	ns	
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		33	46	nC	
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$		15	22	nC	
Q _{gs}	Gate to Source Gate Charge	I _D = 18 A		6.5		nC	
	Gate to Drain "Miller" Charge			4.0		nC	
Q _{gd}	urce Diode Characteristics						
ດ Q _{gd} Drain-Soເ							
Drain-Sou		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.48	0.9		
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2) $V_{GS} = 0 V, I_S = 18 A$ (Note 2)		0.48 0.80	0.9 1.3	V	
Drain-Sou						V ns	

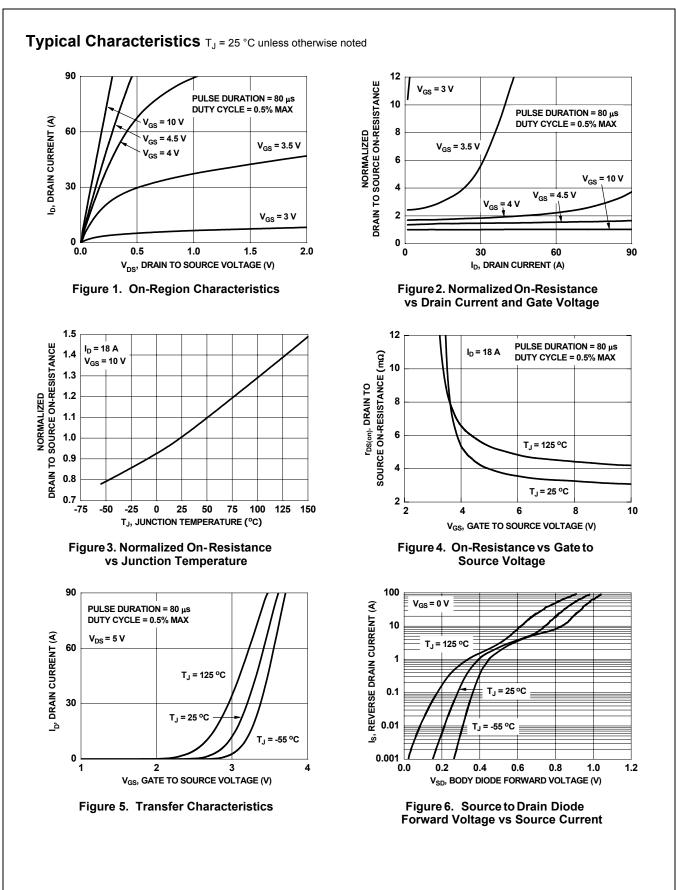
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

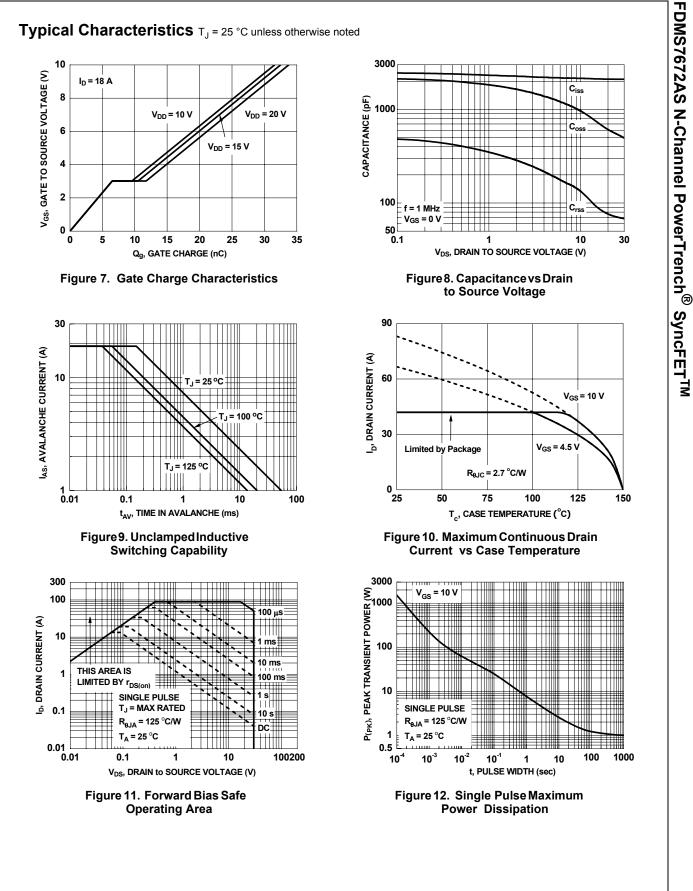
3. E_{AS} of 60 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 11 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 16 A.

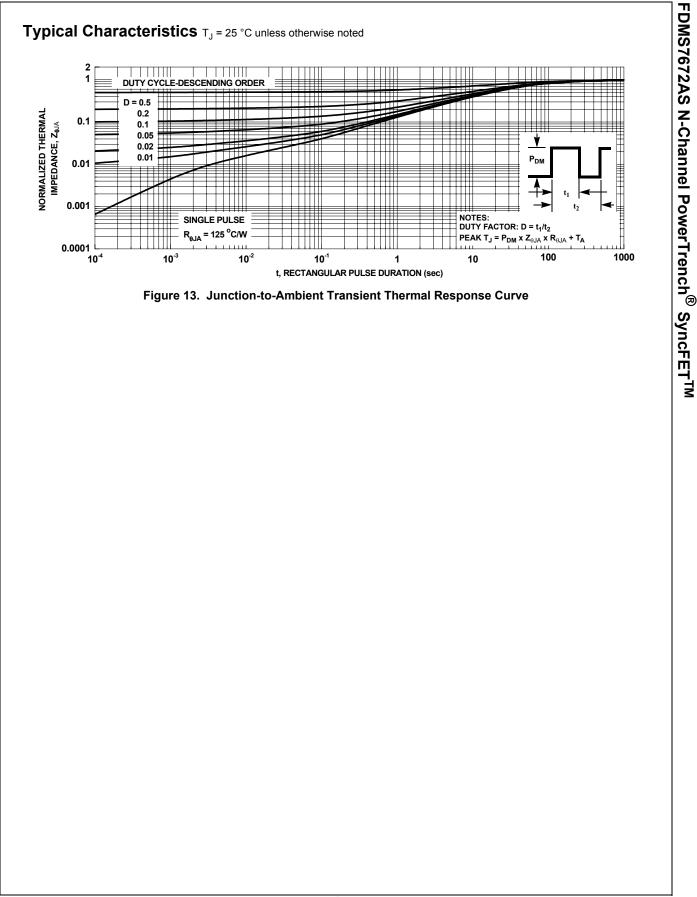
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

FDMS7672AS N-Channel PowerTrench[®] SyncFETTM

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Typical Characteristics (continued)

SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS7672AS.

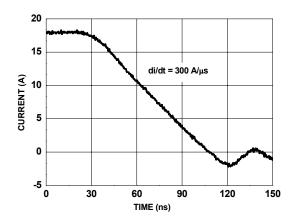
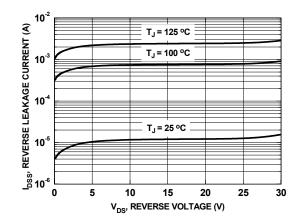
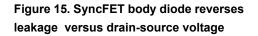


Figure 14. FDMS7672AS SyncFET body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.







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